

Single P-channel MOSFET

ELM14429AA-N

General description

ELM14429AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance. Internal ESD protection is included.

Features

- $V_{ds} = -30V$
- $I_d = -15A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 7.7m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 12m\Omega$ ($V_{gs} = -4.5V$)
- ESD Rating : 4000V HBM

Maximum absolute ratings

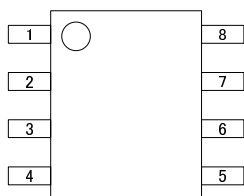
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	-30	V		
Gate-source voltage	V_{gs}	± 20	V		
Continuous drain current	I_d	$T_a = 25^\circ C$	-15.0	A	1
		$T_a = 70^\circ C$	-12.8		
Pulsed drain current	I_{dm}	-80	A	2	
Power dissipation	P_d	$T_a = 25^\circ C$	3.1	W	1
		$T_a = 70^\circ C$	2.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	26	40	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		50	75	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	14	24	$^\circ C/W$	3

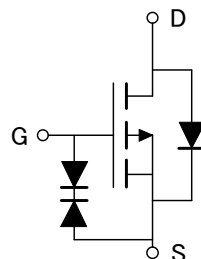
Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

Circuit



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Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV _{dss}	I _d =-250 μA, V _{gs} =0V	-30			V
Zero gate voltage drain current	I _{dss}	V _{ds} =-24V			-1	μA
		V _{gs} =0V		T _j =55°C	-10	
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±1	μA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250 μA	-1.4	-1.8	-2.7	V
On state drain current	I _{d(on)}	V _{gs} =-10V, V _{ds} =-5V	-80			A
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V		6.4	7.7	mΩ
		I _d =-15A	T _j =125°C	8.1		
		V _{gs} =-4.5V, I _d =-10A		9.0	12.0	mΩ
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-15A		50		S
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V		-0.71	-1.00	V
Max. body-diode continuous current	I _s				-5	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}			5355	6400	pF
Output capacitance	C _{oss}	V _{gs} =0V, V _{ds} =-15V, f=1MHz		970		pF
Reverse transfer capacitance	C _{rss}			620		pF
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		2.8	4.0	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Q _g			91	120	nC
Total gate charge (4.5V)	Q _g	V _{gs} =-10V, V _{ds} =-15V		46	60	nC
Gate-source charge	Q _{gs}	I _d =-15A		16		nC
Gate-drain charge	Q _{gd}			21		nC
Turn-on delay time	t _{d(on)}			15.0		ns
Turn-on rise time	t _r	V _{gs} =-10V, V _{ds} =-15V		15.0		ns
Turn-off delay time	t _{d(off)}	R _l =1 Ω, R _{gen} =3 Ω		82.5		ns
Turn-off fall time	t _f			34.0		ns
Body diode reverse recovery time	t _{rr}	I _f =-15A, dI/dt=100A/μs		38	50	ns
Body diode reverse recovery charge	Q _{rr}	I _f =-15A, dI/dt=100A/μs		38		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

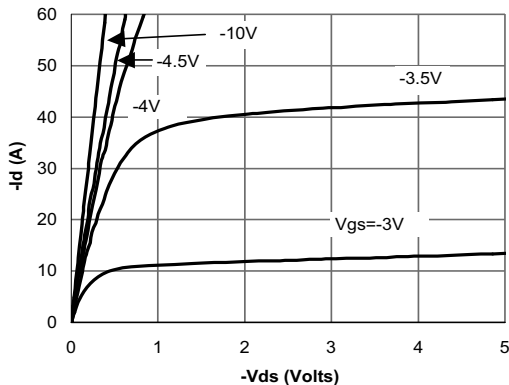


Fig 1: On-Region Characteristics

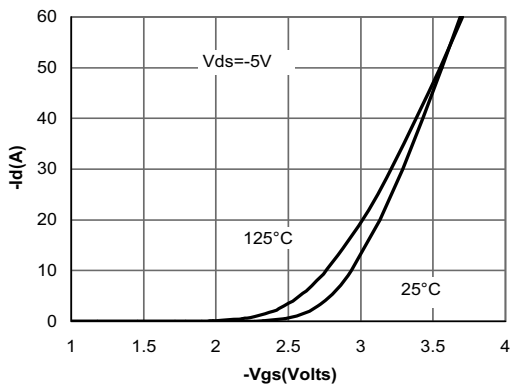


Figure 2: Transfer Characteristics

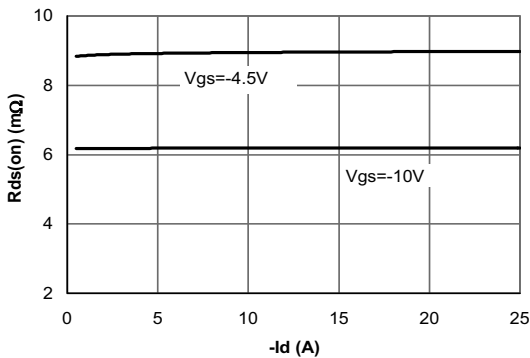


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

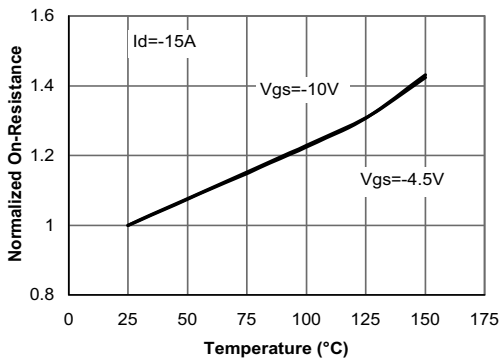


Figure 4: On-Resistance vs. Junction Temperature

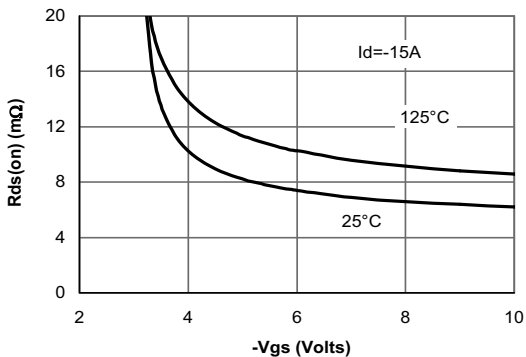


Figure 5: On-Resistance vs. Gate-Source Voltage

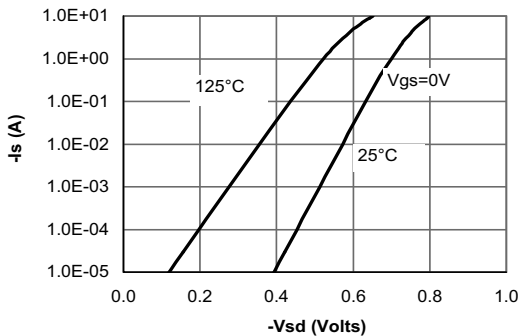


Figure 6: Body-Diode Characteristics

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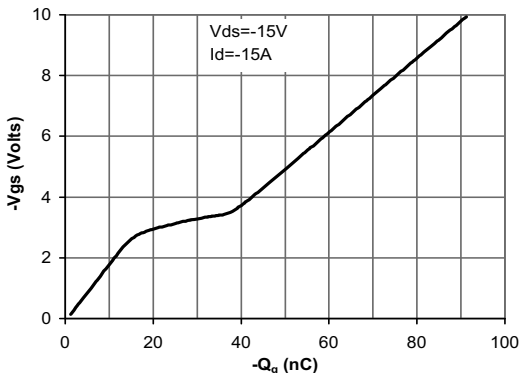


Figure 7: Gate-Charge Characteristics

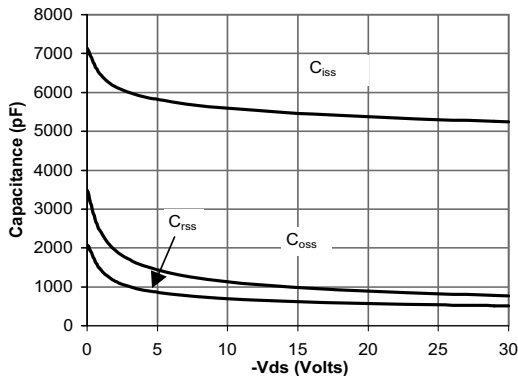


Figure 8: Capacitance Characteristics

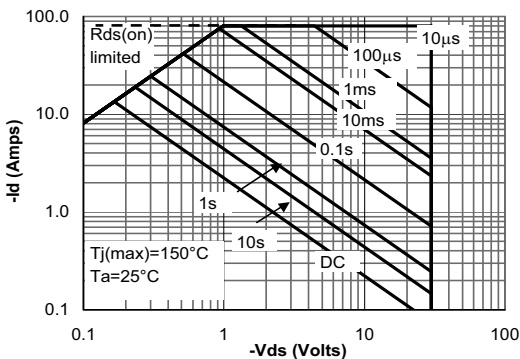


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

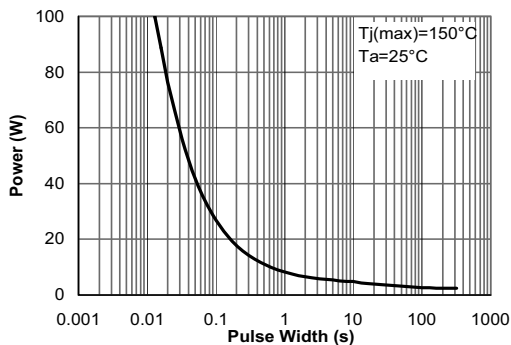


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

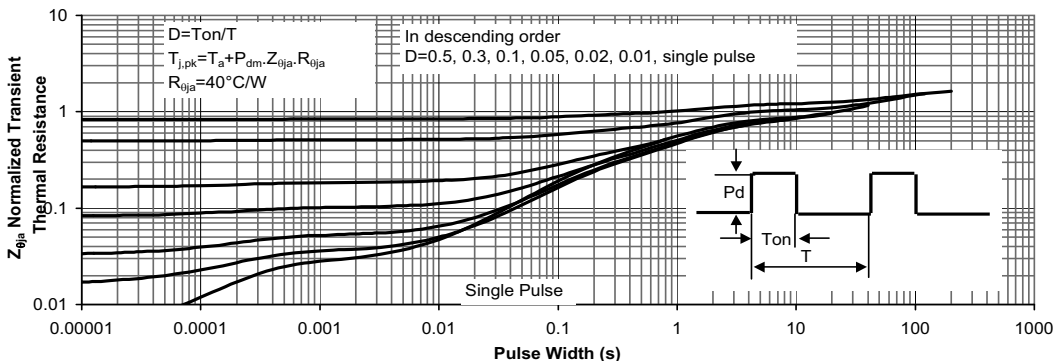


Figure 11: Normalized Maximum Transient Thermal Impedance